

Transistorweg 7 6534 AT Nijmegen The Netherlands T +31 24 371 4499 E info@sencio.nl www.sencio.nl

Lanite 1 Sil BD



Oliver Maiwald CEO - Managing Director



Ignas van Dommelen Manager Sales, Marketing & Development



Sonia Elwardii Sales Engineer



Sencio is an innovative package and assembly solutions design and manufacturing house for MEMs and sensors systems that bridges the gap between your sensor system and the application.

Sencio B.V. is a world class competence center offering development and manufacturing of functional semiconductor assembly solutions for MEMs and sensor systems. From design, package development and prototyping, industrialisation up to volume manufacturing, Sencio works with the customer to carry out a product which fits to the desired mission profile.

*n*Capsulate functional packaging is achieved with a high versatility and compatibility with Sencio's other technologies from exposed die molding to multi-die packaging SiP, among many others. Freeform encapsulate packaging is giving the opportunity to shape the product to the exact requirements of the application. Embedding mechanical systems in electronics using *n*Capsulate offers a real practical solution for system challenges like improved alignment, mounting- and sealing-features, increased measurement accuracy and improved thermal contact.